



- Note:
- Material:
    - Housing: High temperature thermoplastic with g.f.Ul94v-0
    - Contact: copper alloy,t=0.20mm
    - Shell: copper alloy,t=0.25mm
  - Specification:
    - Current rating:1.5PIN 1.8A Max/2.3,4PIN 1A Max.
    - Dielectric withstanding voltage: 100 V(ac) for 1 min.
    - Contact resistance: 30 mΩ Max.
    - Insulation resistance: 100 MΩ Min.
    - Total mating force: 3.57 Kgf Max.
    - Total unmating force: 1.0 Kgf Min
    - Temperature range: -30C~80C

3	SHELL	1	COPPER ALLOY	MATTE TIN PLATED
2	CONTACT	5	COPPER ALLOY	G/F AU/TIN PLATED
1	HOUSING	1	HIGH TEMPERATURE	QUL 94V-0 BLACK
No.	PART NAME	QTY	MATERIAL	REMARK

## CELION SAS

DESCRIPTION MICRO USB SP 全贴 无卷边 有柱无焊盘

DRAWING NO B150326-011 PART NO BUSF05B1N1163

THIRD ANGLE PROJECTION	REVISION	A	UNIT	MM	DRAWN	ROGERLAN
LINEAR	ANGLE	±5°	SCALE	N/A	CHECKED	
X.X ±0.50	X.X ±2°		SHEET	1/1	APPROVED	
XXX ±0.25	XXX ±1°					